

Crystal Group FORCE™RS1104 Rugged ISR Encoder



A new standard for ISR. Crystal Group's rugged ISR encoder module uses the Haivision Makito X1 encoder to deliver real-time streaming of MISB-compliant full motion video capabilities required for demanding intelligence, surveillance and reconnaissance (ISR) applications.

The fully integrated system combines a Makito X1, eight-port switch, six 2.5" SSD storage drives and dual Intel® Xeon® scalable processors into our RS1104 1U server to optimize performance and SWaP. At just under 22 pounds, this ultra-compact rugged server tackles the workload of three separate 1U units, including two simultaneous compression functions via two separate encode engines. This provides a high-quality video stream for machine learning applications running on the RS1104 and a low-bitrate video stream to reach remote users over constrained network links. The system also delivers efficient, high-performance mission computing, storage, layer 2+ switching, and encoding capability.

With our Crystal Group FORCE™ server as the foundation, the RS1104 is engineered to meet strict MIL standards, accelerate compute-intensive workloads, and provide advanced thermal management. This ensures seamless operation in the most demanding, unpredictable situations.

FEATURES...

- Network adaptive H.265/ HEVC encoding
- Interoperable video and metadata
- Built-in management interface
- Ultra-low latency
- Intel® Xeon® Scalable CPU
- Supports 802.1Q VLAN switch with 8K MACs, 4K VLAN and link aggregation (IEEE 802.3ad)
- 8 or 16 external switch ports
- Rugged, lightweight 17-22 lbs. chassis
- Rack mounted 19" depth
- Easily mounted Fixed mount or Jonathan® rails

A clear advantage.

Specifications

Mechanical 1U

Height: 1.75" (4.45 cm)
Width: 16.93" (44.45 cm)
Depth: 19" (48.26 cm)
Weight: 20 lbs. (9.07 kg)

CPU

Intel® CPU architecture options from Intel embedded long-life roadmap

Intel® Xeon® Scalable processor

Expansion

One low-profile or full-height PCle x16 slot

External Bay

Two modular drive bay openings for storage or other functions

Memory

16GB to 2TB DDR4 Reg ECC

Mounting

Fixed or rail, EIA310 19" rackmount

System Board

Option 1: X11SPi-TF, ATX, 2nd Gen Intel® Xeon® Scalable processors

Option 2: X11DPL-i, ATX, 2nd Gen Intel® Xeon® Scalable processors

Option 3: X11DPi-NT, eATX, 2nd Gen Intel® Xeon® Scalable processors

Environmental Standards

MIL-STD-810, Operational Temperature, Method 501, Procedure I/II: -10°C to +50°C, -40°C operational with SSD

MIL-STD-810, Storage, Method 501, Procedure I/II: -30°C to +75°C

MIL-STD-810, Humidity, Method 507, Procedure II: 240 hours with humidity kit

MIL-STD-810, Altitude, Method 500: 10,000ft operation, 20,000ft transport

MIL-STD-810, Vibration, Method 514, Procedure I: 1.5 GRMS, 5-2,000Hz, 75 min/axis

MIL-STD-810, Shock, Method 516, Procedures I/V: 20g, 11msec; 3 axes, each direction

Electromagnetic Compatibility Standards

AC, FCC Compliant²

AC, MIL-STD-461, RE102, CE102 compliant1

DC, MIL-STD-461, RE102, CE102 compliant²

RTCA DO-160 Section 21, Category M²

Cooling

Six high-speed, high-volume fans; CPU temperature controlled

Software Compatibility

Supports Windows 10®, Windows Server 2019®, Windows Server 2016®, VMware®, or Linux®

Power Supply

MIL-STD-704 28 VDC or 120/240 VAC

OPTIONAL FEATURES

- MIL-CIRC power connector
- EMI filter
- Humidity protection
- · Dust filter
- · Data-at-rest

- Sanitization
- · Tamper evident seals
- Tamper proof coatings
- · Chassis intrusion indicator
- USB 3.0 headers

- 1 Test report available
- 2 Designed to meet standard

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